

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	55374	"32" and (cu or copper) and (semiconductor)	US-PGPUB; USPAT	OR	ON	2005/05/11 18:44
L2	181	((electro near2 polish\$) or (electropolish\$)) and (negative with positive) and (electroplat\$3 or (electro near2 (plating plate plated)))	US-PGPUB; USPAT	OR	ON	2005/05/11 18:44
L3	157	L2 not (@ad>"20030710" or @rlad>"20030710")	US-PGPUB; USPAT	OR	ON	2005/05/11 18:44
L4	92	3 and (cu or copper) and (semiconductor)	US-PGPUB; USPAT	OR	ON	2005/05/11 18:44
S1	750	(electro adj polish\$)	US-PGPUB; USPAT	OR	OFF	2005/01/31 15:59
S2	163	(electro near2 polish\$) and (electropolish\$)	US-PGPUB; USPAT	OR	OFF	2005/01/31 16:00
S3	163	(electro near2 polish\$) and (electropolish\$)	US-PGPUB; USPAT	OR	ON	2005/01/31 15:59
S4	3314	(electro near2 polish\$) or (electropolish\$)	US-PGPUB; USPAT	OR	OFF	2005/01/31 16:05
S5	192	S4 and copper and damascene	US-PGPUB; USPAT	OR	OFF	2005/01/31 16:05
S6	1115	((electro near2 polish\$) or (electropolish\$) with (copper cu))	US-PGPUB; USPAT	OR	ON	2005/02/01 14:11
S7	112	S6 and damascene	US-PGPUB; USPAT	OR	ON	2005/02/01 14:11
S8	2052	((438/626) or (438/631-634) or (438/645)).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/02/01 14:11
S9	14304	(438/622-688).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/02/01 14:09
S10	1117	((electro near2 polish\$) or (electropolish\$) with (copper cu))	US-PGPUB; USPAT	OR	ON	2005/02/01 14:11
S11	113	S10 and damascene	US-PGPUB; USPAT	OR	ON	2005/02/01 15:24
S12	17	S8 and S10	US-PGPUB; USPAT	OR	ON	2005/05/11 16:17
S13	13	S8 and S11	US-PGPUB; USPAT	OR	ON	2005/02/01 14:11
S14	53	S9 and S10	US-PGPUB; USPAT	OR	ON	2005/02/01 15:23
S15	0	S13 not S12	US-PGPUB; USPAT	OR	ON	2005/02/01 15:23
S16	36	S14 not S12	US-PGPUB; USPAT	OR	ON	2005/02/01 15:23

S17	1	("6739953").PN.	US-PGPUB; USPAT	OR	OFF	2005/02/01 16:38
S18	1	S17 and (electroplating plating)	US-PGPUB; USPAT	OR	OFF	2005/02/01 17:01
S19	1	09/795115	US-PGPUB; USPAT	OR	OFF	2005/02/01 17:01
S20	0	S19 and seed	US-PGPUB; USPAT	OR	OFF	2005/02/01 20:05
S21	4097	electroplating with current	US-PGPUB; USPAT	OR	OFF	2005/02/01 20:05
S22	30	S21 and S8	US-PGPUB; USPAT	OR	OFF	2005/02/01 20:05
S23	2116	((438/626) or (438/631-634) or (438/645)).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/05/11 16:17
S24	1185	((electro near2 polish\$) or (electropolish\$) with (copper cu))	US-PGPUB; USPAT	OR	ON	2005/05/11 16:34
S25	20	S23 and S24	US-PGPUB; USPAT	OR	ON	2005/05/11 16:18
S26	16	S25 not (@ad>"20030710" or @rlad>"20030710")	US-PGPUB; USPAT	OR	ON	2005/05/11 16:35
S27	272	((electro near2 polish\$) or (electropolish\$)) and (negative and positive) and (electroplat\$3 or (electro near2 (plating plate plated)))	US-PGPUB; USPAT	OR	ON	2005/05/11 16:41
S28	235	S27 not (@ad>"20030710" or @rlad>"20030710")	US-PGPUB; USPAT	OR	ON	2005/05/11 16:41
S29	186	S27 not (@ad>"20020711" or @rlad>"20020711")	US-PGPUB; USPAT	OR	ON	2005/05/11 16:39
S30	181	((electro near2 polish\$) or (electropolish\$)) and (negative with positive) and (electroplat\$3 or (electro near2 (plating plate plated)))	US-PGPUB; USPAT	OR	ON	2005/05/11 16:48
S31	11	((electro near2 polish\$) or (electropolish\$)) and (negative with positive with (switch\$3 chang\$3)) and (electroplat\$3 or (electro near2 (plating plate plated)))	US-PGPUB; USPAT	OR	ON	2005/05/11 16:52
S32	157	S30 not (@ad>"20030710" or @rlad>"20030710")	US-PGPUB; USPAT	OR	ON	2005/05/11 18:44
S33	9	S31 not (@ad>"20030710" or @rlad>"20030710")	US-PGPUB; USPAT	OR	ON	2005/05/11 16:49
S35	148	S32 not S33	US-PGPUB; USPAT	OR	OFF	2005/05/11 16:47

S36	12	((electro near2 polish\$) or (electropolish\$)) same (negative with positive) same (electroplat\$3 or (electro near2 (plating plate plated)))	US-PGPUB; USPAT	OR	ON	2005/05/11 16:49
S37	9	S36 not S31	US-PGPUB; USPAT	OR	ON	2005/05/11 16:49
S38	9	S37 not (@ad>"20030710" or @rlad>"20030710")	US-PGPUB; USPAT	OR	ON	2005/05/11 16:49
S39	2	S31 not S33	US-PGPUB; USPAT	OR	ON	2005/05/11 16:52